

## 5.3 MIPI—In Wearables

# **USE CASES**



### In AR Glasses:

- DSI-2 over C/D-PHY to drive an advanced, high resolution heads-up display, enabling low-power 'Smart Region of Interest' mode when watch is in standby mode
- CSI-2 over C/D-PHY to connect a high-resolution camera, enabling low-power vision inferencing
- SoundWire to provide a shared, two-wire interface, to drive speakers and microphones, enabling noise cancellation, low-power 'keyword' activation, and low-EMI operation to achieve tighter packaging of components with minimal EMC shielding
- · RFFE within radio communications module

### In Smartwatches:

- DSI-2 over C/D-PHY to drive an advanced high-resolution display, enabling low-power 'Smart Region of Interest' mode when watch is in standby mode
- MIPI Touch to enable touchscreen user interface
- C-PHY physical interface, reducing line and pin counts and generating low EMI, allowing smaller devices requiring less EMC shielding
- I3C to provide a shared, two-wire interface, to connect heart-rate, motion and other sensors and simple UI components such as LEDs and haptics
- SoundWire to drive advanced audio components such as microphones and headsets
- · RFFE within radio communications module

# Example Smart Watch Schematic Touch Specifications Family of Specifications Family of Specifications Touch Adaptation Layer over I3C Display(s) Display(s) Sound\(\frac{\text{Wire}}{\text{LED}}\) For Example Radio For Example Radio Codec Power Amp Power Amp Radio Switch Switch Switch Switch Antenna Tuner RAC Antenna Tuner RAC Antenna Tuner RAC Antenna Tuner CONTROLLAR DATA RACELETONTROLLAR HOST CONTROLLAR RACELETONTROLLAR RETERNACE SOFTWARE RETERNACE SOFTWARE

### In Smart Earbuds:

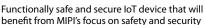
- I3C to provide a shared, two-wire interface, to connect sensors and simple UI components such as LEDs and buttons
- SoundWire providing a shared, two-wire interface, to drive high-quality speakers and microphones, enabling noise cancellation, low-power 'keyword' activation, and low-EMI operation to achieve tighter packaging of components with minimal EMC shielding

### **In Smart Sneakers:**

- I3C to provide a shared, two wire interface to connect:
- Simple UI components such as small dot-matrix displays, LEDs and switches
- Motion and pressure sensors
- Motor actuators









IoT device with constrained power supply that will benefit from use of MIPI low-power interfaces



IoT device with wide-area cellular connectivity that will benefit from MIPI's 5G preparedness



Size-constrained, tightly packaged IoT device, benefiting from MIPI's low pin count, low wire count, low EMI interfaces